IPC ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIE	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					ials and Mfg Information			
upplier Inforn	nation						·							
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi											2025-05-14			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	ards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
uthorized Represe	entative*	Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewa	ards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
Requeste	er Item Number			Mfr Item Name			Effective Date	te Version Manufacturing Site		W	eight*	UOM	Unit Type	
				Direct Sense SR con	ntrol_r		2025-05-14 TAD		AD	17	7.874	mg	Each	
	Process Information						I				_			
			· · · · · · · · · · · · · · · · · · ·		STD-020 MSL	Rating	Peak Process Body Tempera		T *				per of Reflow Cyc	eles
•	n (Sn) - annealed	C	U Alloy	1			260		C	30	second	s 3		
omments														
	ime at peak temperature													
or more informati	on regarding material co	mposition p	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's St											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.779	mg	Supplier	Silicon (Si)	7440-21-3		0.779	mg
Die Attach	0.099	mg		Epoxy resin	proprietary data		0.0099	mg
			Supplier	Silver (Ag)	7440-22-4		0.0792	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0099	mg
Lead Frame	8.252	mg	Supplier	Silver (Ag)	7440-22-4		0.022	mg
			Supplier	Zinc (Zn)	7440-66-6		0.01	mg
			Supplier	Iron (Fe)	7439-89-6		0.198	mg
			Supplier	Copper (Cu)	7440-50-8		8.0201	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Mold Compound-Black	7.588	mg		Epoxy resin	proprietary data		0.5312	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1897	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.5691	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0379	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.0704	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.1897	mg
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg